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Virtual Testing of Material Heating for a Semi-Solid Forming Process

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Abstract: The research in the field of forming processes is focused on the development of novel progressive technologies leading to the significant enhancement of production efficiency and quality of final products by concurrent decrease in manufacturing costs and energy requirements on single production operations.

Considerable microstructure refinement and homogenity increase belong to the typical consequences of rapid cooling and non-equilibrium solidification of melts. The fundamental physical and metallurgical principles of rapid solidification processing can be exploited by the manufacturing of small products using the forming in semi-solid state. Thixoforming requires the material heating to higher temperatures in comparison with conventional hot forming technologies. However, considering the small volumes of heated material, effective direct electrical heating methods, induction heating or heating in electromagnetic levitation can be exploited with many advantages. After semiproduct heating to the temperatures between solidus and liquidus, the material is formed in an open or closed die ensuring the intensive heat extraction from treated material and its rapid solidification. As a result of the forming in semi-solid state, the product with very accurate shape, fine microstructure and specific material properties can be obtained.

The paper deals with the computer testing of direct electric heating of high alloyed tool steel for a semi-solid forming process using the program code ANSYS. The influence of chosen geometrical and technological parameters on the temperature distribution in heated semiproducts is evaluated.

Keywords: forming, semi-solid state, temperature fields, direct electric heating, numerical simulation, ANSYS

1. Introduction

Semi-solid forming belongs to the relatively new near-net-shape technologies dedicated for manufacturing products with complex geometries and significantly improved material properties [1-3]. Semi-solid metal forming takes place at temperatures between solidus and liquidus temperatures. As a result of this, it combines advantages of both metal forging and metal casting processes. Comparing with conventional die casting, it provides possibility to produce parts with substantially higher quality but on the other hand cheaper than using

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classical forging processes. Lower processing temperature and non-turbulent flow of semisolid material lead to a quite low degree of shrinkage and porosity of final products [3, 4].

Moreover, the shear rate dependent viscosity of semi-solid materials allows to produce rather complicated geometries applying single forming operation with considerably lower forces than in conventional hot forging [5]. To obtain very fine and homogeneous microstructure, it is necessary to apply deformation at the temperatures when the initial slurry material consists of accurately defined portions of liquid and solid phases, typically of 40% liquid and 60% solid [4, 6-7]. Solid particles with non-dendritic globular shape should be uniformly distributed in the liquid phase.

Except of low temperature aluminum and magnesium alloys, the great attention is paid in the last years to the semi-solid forming of steels [3, 5-9]. High temperatures connected with semi-solid steel forming processing require the exploitation of suitable tool materials. Specific heating control is also necessary to maintain the proper temperature of material with required fractions of liquid and solid phases.

This paper is aimed at the numerical simulation and virtual testing of direct electric heating of semiproducts from the X210Cr12 steel before their semi-solid forming. The heating process is realised directly in a die. The influence of chosen geometrical and technological parameters on the temperature distribution in heated semiproducts is examined.

2. Experimental Equipment and Material

Experimental die for semi-solid material forming consists of two parts which are after bolting inserted into the forming machine. A semiproduct is heated up through copper electrodes using direct electric heating. After heating, it is pressed down and the semi-solid material will fill a die cavity.

According to good thixotropic behaviour, the X210Cr12 steel (Table 1) was chosen as an experimental material. Applying the program code JMatPro, the dependence of liquid fraction on the temperature for this steel was calculated (Fig. 1) [7]. The X210Cr12 steel starts to melt at the temperature of 1225°C. The temperature interval from 1290°C to 1330°C corresponds to the liquid fraction of 40-60 % suitable for semi-solid forming. It means that before forming, the material should be heated up to the temperature from this range. Moreover, solid particles should have globular shape.

С	Cr	Mn	Si	Ni	Р	S
1.8	11	0.2	0.2	0.5	0.03	0.035

Fable 1.	Chemical	composition	of X210Cr12	experimental steel



Fig. 1. Dependence of liquid fraction on the temperature

3. Simulation Model

Numerical analysis and simulation of direct electric heating of semiproducts to the thixoforming temperature were performed by the finite element code ANSYS 10.0 using solution of coupled electric and thermal problems [10-12]. Coupling of electric and thermal analyses by direct electrical heating (Fig. 2) is determined by the temperature dependence of electrical properties of heated material and on the other hand by the dependence of generated Joule heat on electrical properties. Joule heat as a result of electric analysis represents the load (internal energy source) for transient thermal analysis. Computed temperature distribution creates input data for the following electric analysis.



Fig. 2. Scheme of the solution of coupled electric and thermal problem

Analysis of electric fields is based on the solution of Laplace equation in the form [13]

 $div(\sigma \operatorname{grad} V) = 0$

where σ is electric conductivity and V electric potential.

Transient temperature field in solids can be described by Fourier-Kirchhoff partial differential equation [14, 15]

$$c\rho \frac{\partial T}{\partial t} = div \left(\lambda \operatorname{grad} T\right) + q_{v}, \qquad (2)$$

in which ρ is the density, *c* is the specific heat capacity, λ is the thermal conductivity and q_v is the volume density of internal heat sources, i. e. the heat generated in unit volume per second. By resistance heating this term corresponds to the Joule heat.

For the analysis of temperature fields by direct electric heating, three experimental semiproducts of cylindrical shape with the diameters of 6 mm and the high of 22 mm, 26 mm and 28 mm respectively, were considered (Fig. 3a). The semiproducts have end in the form of the frustum of the cone.



Fig. 3. Geometrical and FEM model of experimental semiproduct

Copper electrodes were modeled without construction details (threads, curvatures...). Finite elements models of the semiproduct (Fig. 3b) and a die were simplified to the plane- and axisymmetric. Thermal and electric properties of the X210Cr12 steel (Fig. 4) were obtained using the program code JMatPro. Temperature dependent material properties of a die, copper electrodes and air according to [15-17] were used. Values of emmisivity for single materials were considered to be constant: $\varepsilon_{steel} = 0.8$; $\varepsilon_{die} = 0.3$ a $\varepsilon_{Cu} = 0.037$.

The initial temperature of materials was supposed to be 20 °C. The copper electrode was on the top surface loaded by the time dependent voltage. Neutral voltage was defined at the semiproduct in the symmetry plane. In the narrow space filled by air, the heat transfer only by conduction was considered. The radiative heat transfer was taken into account mutually between semiproduct, die and electrodes. Copper electrodes were in the area of threads cooled by water. Other surface areas of electrodes and a die were cooled down by free convection and radiation to the surrounding air with the temperature of 20 °C.



Fig. 4. Thermal and electric properties of the X210Cr12 steel, die and copper electrodes

Developed simulation model was verified using experimental temperature measurements by direct electric heating of the semiproduct with the length of 40 mm. Measured temperatures were compared with temperatures computed in the node corresponding to the thermocouple location (Fig. 5a). The mean relative deviation of measured and calculated temperatures is 0.54 % with the maximum of 6.9 % at the beginning of the heating process (Fig. 5b).



Fig. 5. Time history of a) measured and calculated temperatures and b) relative error of calculated temperatures

4. Analysis of Temperature Fields by Direct Electrical Heating before Forming

Based on the described simulation model, the analysis of temperature fields was carried out with the aim to found out the influence of chosen heating parameters on the temperature distribution in a heated semiproduct and the volume of semi-solid material with the temperature from the required temperature interval from 1290 °C to 1330 °C. Using numerical experiments, the influence of following parameters on the temperature fields in the semiproduct was investigated:

- the heating rate to the solidus temperature,
- the holding time at the temperature above solidus temperature,
- geometrical characteristics of a semiproduct.

4.1 Influence of the heating rate on the temperature fields in a semiproduct

The semiproduct with the length of 40 mm (Fig. 3a) was heated up with the average heating rate of 12.5 K.s⁻¹, 23 K.s⁻¹ and 46 K.s⁻¹. The heating rate of 23 K.s⁻¹ corresponds to the average heating rate by performed experimental temperature measurement. The voltage rise was supposed to be linear after the second second (Fig. 6a). Resulting temperature increase in the node 1 is depicted in Fig. 6b.



Fig. 6. Time dependence of a) applied voltage and b) temperatures in the node 1 for the analysed heating rates



Fig. 7. Temperature distribution in the semiproduct in the time of a) 15 seconds, b) 30 seconds, c) 45 seconds and d) 55 seconds

The temperature distribution in the semiproduct heated up with the heating rate of 23 K.s⁻¹ after chosen heating periods is illustrated in Fig. 7. The heating process is uniform, maximal temperatures in the conical part of a semiproduct are lower than 200 °C.

Figure 8 documents the dependence of temperatures along rotation axis for chosen heating rates in the moment when the temperature in the semiproduct centre of gravity reaches 1330°C. The increase in heating rate results in the enlargement of mushy zone. For the die filling and attainment of required microstructure and material properties of the final product, the maximal volume of molten material before deformation is requested. The volume of semi-solid material increases with the increase in heating rate from 140 mm³ to 160 mm³ (Table 2).

The volume of material with the temperatures from the recommended temperature interval for thixoforming from 1290° C to 1330° C is maximal (102.21 mm^3) by the heating rate of 46 K.s^{-1} . However, it is necessary to be aware that the solidus temperature shifts to higher values by increased heating rate [8]. In this reason, it is recommended to perform DTA experiments with the aim to specify the dependence of solidus temperature on the heating rate.



Fig. 8. Temperature distribution along the rotational axis in the time when the temperature in the centre of gravity reaches 1330°C

Table 2.	Dependence of	of the volume	of semi-solid	material on	the heating rate
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Volume of the meterial with the temperature	Heating rate			
volume of the material with the temperature	12.5 K.s ⁻¹	23 K.s ⁻¹	46 K.s ⁻¹	
above solidus temperature [mm ³]	142.43	149.71	160.24	
in the interval from 1290°C to 1330°C [mm ³]	88.40	91.48	102.21	

4.2 Influence of the holding time on the temperature fields in a semiproduct

The semiproduct with the high of 40 mm was heated up during the time of 60 seconds to the temperature of 1308°C in the node 1, i. e. in the position of temperature measurement by thermocouple. After this time period, the surface temperature in the node 1 remains constant by the time of 120 seconds (Fig. 9). The temperature increase in the axis of a semiproduct (Fig. 10) and the volume of semi-solid material was investigated.

Extension of holding time results in a slight temperature rise in the rotation axis, each 10°seconds approximately by 1°C. The volume of semi-solid material with the temperature above solidus temperature of 1225°C does not change during considered holding time (Fig. 9). Only the volume of material with the temperature from the temperature interval from 1290°C to 1330°C slightly increases from 58.6 mm³ to 63.2 mm³ by the extension of holding time from 30 seconds to 60 seconds.



Fig. 9. Time dependence of temperature in the node 1 and of the volume of semi-solid material



Fig. 10. Dependence of temperatures along rotation axis for chosen holding times

4.3 Influence of geometrical characteristics of a semiproduct

In the following step, the influence of semiproduct geometry on the temperature distribution and on the volume of semi-solid material was examined. Three semiproducts with the length of 40 mm, 38 mm a 36 mm (Fig. 3a) were compared by the loading with the same voltage. It is clear that the heating of the shortest semiproduct is the fastest (Fig. 11). The heating time to the solidus temperature is ranging from 40.7 s to 50.8 s for the semiproduct with maximum dimensions.

The volume of semi-solid material increases from 113 mm³ to approximately 150 mm³ (Table 3). From this volume, about 61% of material is heated to the required temperature interval from 1290° C to 1330° C.



Fig. 11. Time history of temperature in the centre of gravity of semiproducts

Table 3.	Dependence o	of the volume o	of semi-solid	material on	the semi	product	length
	1						0

Volume of the meterial with the temperature	Length of a semiproduct			
volume of the material with the temperature	40 mm	38 mm	36 mm	
above solidus temperature [mm ³]	149.71	127.23	113.09	
in the interval from 1290°C to 1330°C [mm ³]	91.48	80.30	70.68	

The mushy zones with the temperatures from the range from 1225°C to 1330°C in the semiproducts with different lengths are illustrated in Fig. 12. According to the volume of material with the temperature above solidus temperature of 1225°C, the semiproduct with the length of 40 mm is recommended for the following experimental forming in semi-solid state.



Fig. 12. Mushy zone with the temperatures from the range from 1225°C to 1330°C in the semiproduct with the length of a) 40 mm, b) 38 mm and c) 36 mm

5. Conclusion

The paper deals with modeling and numerical simulation of temperature fields by direct electric heating of semiproducts from the X210Cr12 steel before their forming in semi-solid state. Based on the developed and verified simulation model, numerical analysis of electric and temperature fields by the program code ANSYS 10.0 was performed. Virtual testing of material heating was aimed at the evaluation of the influence of chosen parameters (heating rate, holding time and geometric characteristics of semiproducts) on the temperature distribution in the heated semiproduct and the volume of semi-solid material at the end of heating.

Contrary to the real experiment during which temperatures can be measured only in the single point at the semiproduct surface, numerical experiments and computer simulation enable deeper insight into the investigated process of electric heating. Performed virtual (numerical) testing of material heating represents initial studies providing the basic idea of temperature distribution in a heated semiproduct. Based on the obtained results, parameters of direct electric heating for the process of forming in semi-solid state will be modified and experimentally tested.

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